

IN THE SPECIFICATION:

Please amend the specification as follows:

[0037] Preferably, the laser marking tape used in the method of the present invention will comprise materials which are resistant to blistering, bubbling, or release of volatile components when contacted with an energy source. One such tape material which is suitable for use in an ablative laser marking process is comprised of polytetrafluoroethylene (~~PFTE~~) (PTFE), a material which may be made colored with various pigments, and which is suitably resistant to blistering, bubbling, or release of volatile components when contacted with a laser beam.